MOS FIELD EFFECT TRANSISTOR 2SK2479

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

NEC

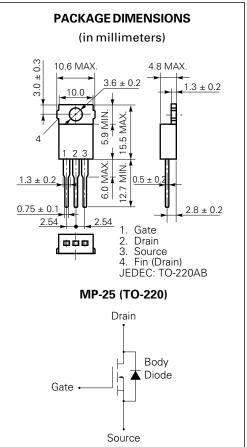
The 2SK2479 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

- Low On-Resistance
 - $R_{DS(on)} = 7.5 \ \Omega \ (V_{GS} = 10 \ V, \ I_{D} = 2.0 \ A)$
- Low C_{iss} $C_{iss} = 485 \text{ pF TYP}.$
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

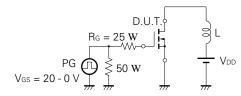
| Drain to Source Voltage | VDSS | 900 | V |
|--|-------------------|-------------|----|
| Gate to Source Voltage | Vgss | ±30 | V |
| Drain Current (DC) | D(DC) | ±3.0 | А |
| Drain Current (pulse)* | D(pulse) |) ±8.0 | А |
| Total Power Dissipation (T _c = 25 °C) | P T1 | 70 | W |
| Total Power Dissipation (T _A = 25 $^{\circ}$ C) | P T2 | 1.5 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature | Tstg | –55 to +150 | °C |
| Single Avalanche Current** | las | 3.0 | А |
| Single Avalanche Energy** | Eas | 5.4 | mJ |
| * PW - 10 μs, Duty Cycle - 1 % | | | |
| ** Starting $T_{ch} = 25 \ ^{\circ}C$, $R_G = 25 \ \Omega$, $V_{GS} = 20 \ \Omega$ | 0 V \rightarrow | 0 | |

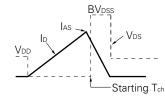


ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

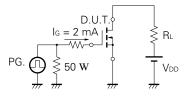
| CHARACTERISTIC | SYMBOL | MIN. | TYP. | MAX. | UNIT | TEST CONDITIONS |
|-------------------------------------|----------------------|------|------|------|------|---|
| Drain to Source On-State Resistance | RDS(on) | | 5.6 | 7.5 | Ω | Vgs = 10 V, Id = 2.0 A |
| Gate to Source Cutoff Voltage | V _{GS(off)} | 2.5 | | 3.5 | V | Vds = 10 V, Id = 1 mA |
| Forward Transfer Admittance | y _{fs} | 0.8 | | | S | Vds = 20 V, Id = 2.0 A |
| Drain Leakage Current | IDSS | | | 100 | μA | Vds = Vdss, Vgs = 0 |
| Gate to Source Leakage Current | lgss | | | ±100 | nA | $V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$ |
| Input Capacitance | Ciss | | 485 | | pF | V _{DS} = 10 V |
| OutputCapacitance | Coss | | 75 | | pF | V _{GS} = 0 |
| Reverse Transfer Capacitance | Crss | | 10 | | pF | f = 1 MHz |
| Turn-On Delay Time | td(on) | | 12 | | ns | ID = 2.0 A |
| Rise Time | tr | | 5 | | ns | V _{GS} = 10 V |
| Turn-Off Delay Time | td(off) | | 35 | | ns | Vdd = 150 V |
| Fall Time | tr | | 8 | | ns | R _G = 10 Ω |
| Total Gate Charge | Q _G | | 17 | | nC | ID = 3.0 A |
| Gate to Source Charge | Q _{GS} | | 3 | | nC | V _{DD} = 450 V |
| Gate to Drain Charge | Qgd | | 8 | | nC | Vgs = 10 V |
| Body Diode Forward Voltage | VF(S-D) | | 1.0 | | V | IF = 3.0 A, VGS = 0 |
| Reverse Recovery Time | trr | | 670 | | ns | IF = 3.0 A, VGS = 0 |
| Reverse Recovery Charge | Qrr | | 3.0 | | μC | di/dt = 50 A/µs |

Test Circuit 1 Avalanche Capability

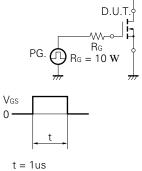




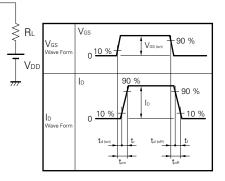
Test Circuit 3 Gate Charge



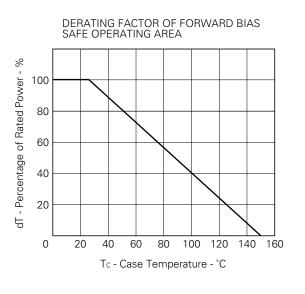
Test Circuit 2 Switching Time



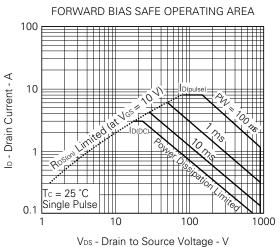
Duty Cycle £ 1 %



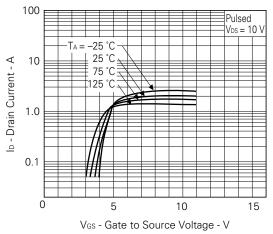
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

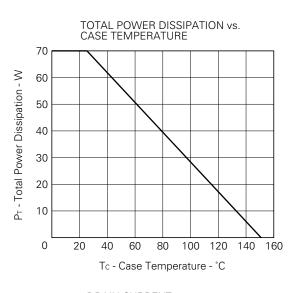


TYPICAL CHARACTERISTICS (TA = 25 °C)

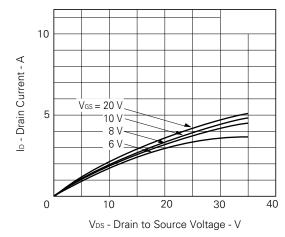








DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



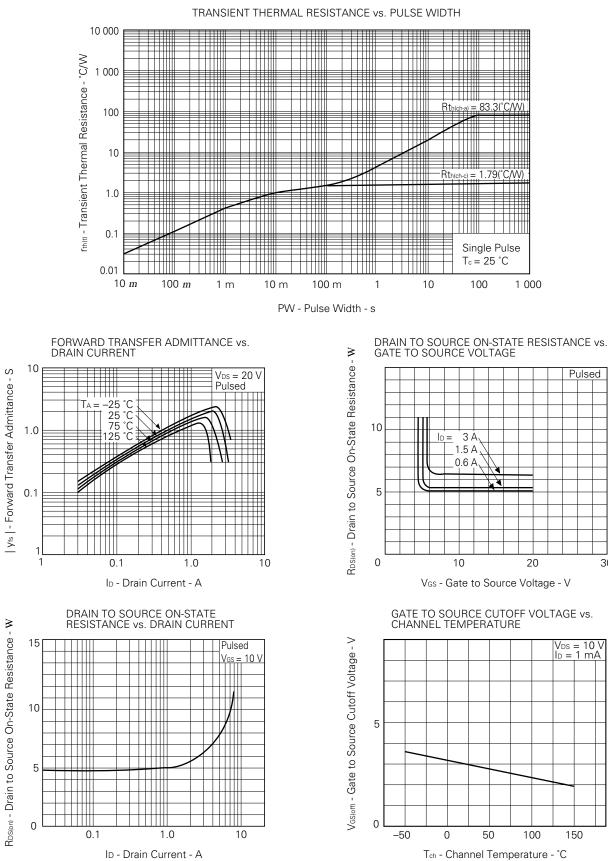


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Vos = 10 V Io = 1 mA

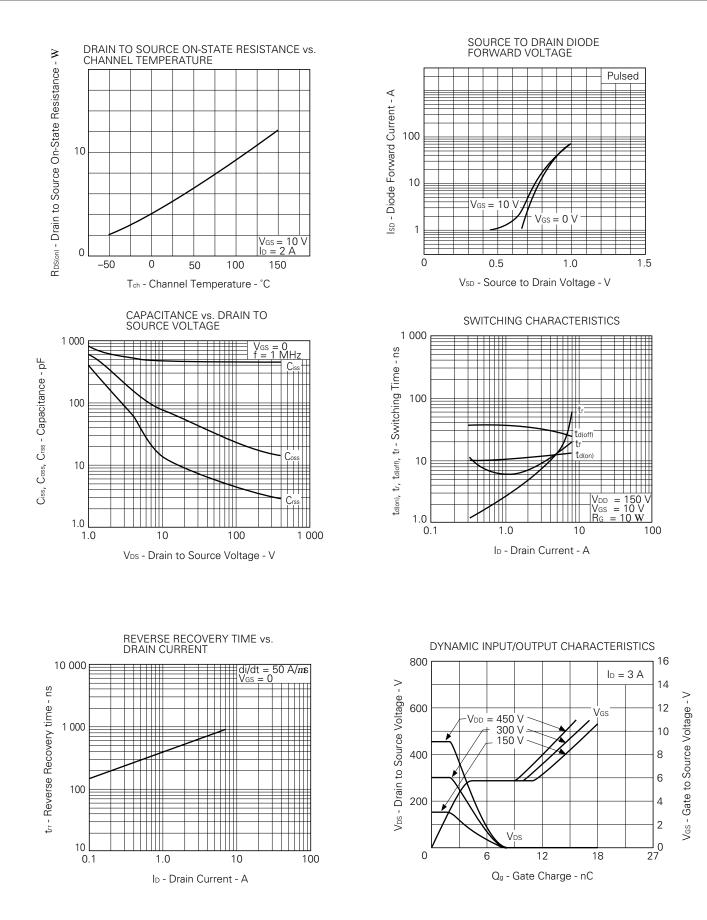
150

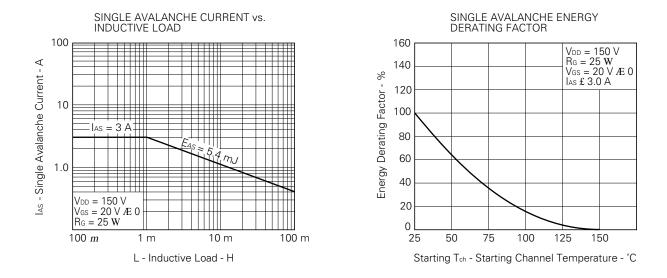
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Pulsed

RDS(on) - Drain to Source On-State Resistance - W





REFERENCE

| Document Name | Document No. |
|--|--------------|
| NEC semiconductor device reliability/quality control system. | TEI-1202 |
| Quality grade on NEC semiconductor devices. | IEI-1209 |
| Semiconductor device mounting technology manual. | IEI-1207 |
| Semiconductor device package manual. | IEI-1213 |
| Guide to quality assurance for semiconductor devices. | MEI-1202 |
| Semiconductor selection guide. | MF-1134 |
| Power MOS FET features and application switching power supply. | TEA-1034 |
| Application circuits using Power MOS FET. | TEA-1035 |
| Safe operating area of Power MOS FET. | TEA-1037 |

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Anti-radioactive design is not implemented in this product.